

INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Directly heated negative temperature coefficient thermistors –
Part 2: Sectional specification – Surface mount negative temperature coefficient
thermistors**

**Thermistances à coefficient de température négatif à chauffage direct –
Partie 2: Spécification intermédiaire – Thermistances à coefficient de
température négatif pour montage en surface**

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**DIRECTLY HEATED NEGATIVE TEMPERATURE
COEFFICIENT THERMISTORS –****Part 2: Sectional specification –
Surface mount negative temperature coefficient thermistors**

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The technical content is therefore identical to the base edition and its amendment and has been prepared for user convenience. A vertical line in the margin shows where the base publication has been modified by amendment 1. Additions and deletions are displayed in red, with deletions being struck through.

International Standard IEC 60539-2 has been prepared by IEC technical committee 40: Capacitors and resistors for electronic equipment.

This bilingual version, published in 2010-07, corresponds to the English version.

The French version of this standard has not been voted upon.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of the base publication and its amendments will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

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DIRECTLY HEATED NEGATIVE TEMPERATURE COEFFICIENT THERMISTORS –

Part 2: Sectional specification – Surface mount negative temperature coefficient thermistors

1 General

1.1 Scope

This part of IEC 60539 is applicable to surface mount directly heated negative temperature coefficient thermistors, typically made from transition metal oxide materials with semiconducting properties. These thermistors have metallized connecting pads or soldering strips and are intended to be mounted directly on to substrates for hybrid circuits or on to printed boards.

1.2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-2-2:1974, *Environmental testing – Part 2: Tests – Tests B: Dry heat*
Amendment 1 (1993)
Amendment 2 (1994)

IEC 60068-2-14:1984, *Environmental testing – Part 2: Tests – Test N: Change of temperature*
Amendment 1 (1986)

IEC 60068-2-30:1980, *Environmental testing – Part 2: Tests – Test Db and guidance: Damp heat, cyclic (12 + 12-hour cycle)*
Amendment 1 (1985)

IEC 60068-2-58:1999, 2004, *Environmental testing – Part 2-58: Tests – Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)*

IEC 60068-2-78: *Environmental testing – Part 2-78: Tests – Test Cab: Damp heat, steady state*

IEC 60410:1973, *Sampling plans and procedures for inspection by attributes*

IEC 60539-1:2002, *Directly heated negative temperature coefficient thermistors – Part 1: Generic specification*

1.3 Information to be given in a detail specification

Detail specifications shall be derived from the relevant blank detail specification.

Detail specifications shall not specify requirements inferior to those of the generic, sectional or blank detail specification. When more severe requirements are included, they shall be listed in 1.9 of the detail specification and indicated in the test schedules, for example, by an asterisk.

NOTE The information given in 1.3.1 may for convenience, be presented in tabular form.

The following information shall be given in each detail specification and the values quoted shall preferably be selected from those given in the appropriate clause of this sectional specification.

1.3.1 Outline drawing and dimensions

There shall be an illustration of the thermistor as an aid to easy recognition and for comparison with others. Dimensions and their associated tolerances, which affect interchangeability and mounting, shall be given in the detail specification. All dimensions shall preferably be stated in millimetres; however, when the original dimensions are given in inches, the converted metric dimensions in millimetres shall be added.

Normally, the numerical values shall be given for the length, width and height of the body. When necessary, for example when a number of items are covered by a detail specification, the dimensions and their associated tolerances shall be placed in a table below the drawing.

When the configuration is other than described above, the detail specification shall state such dimensional information as will adequately describe the thermistor.

1.3.2 Mounting

The detail specification shall give guidance on methods of mounting for normal use. Mounting for test and measurement purposes (when required) shall be in accordance with 4.27 of IEC 60539-1.

1.3.3 Ratings and characteristics

1.3.3.1 Particular characteristics

Additional characteristics may be listed when they are considered necessary to specify the component adequately for design and application purposes.

1.3.3.2 Marking

See 2.4 of IEC 60539-1.

1.4 Terminology

See 2.2 of IEC 60539-1.

2 Preferred ratings and characteristics

2.1 Tolerances on rated zero-power resistance

Preferred values of tolerances on zero-power resistance are:

$\pm 1\%$, $\pm 2\%$, $\pm 3\%$, $\pm 5\%$, $\pm 10\%$.

2.2 Climatic categories

The upper and lower category temperatures and the duration of the damp-heat steady-state test shall be selected from Table 1.

Table 1 – Upper and lower category temperatures and duration of the damp heat test

| | |
|----------------------------------|---------------------------------|
| Lower category temperature °C | -55, -40, -25, -10, -5, +5 |
| Upper category temperature °C | 70, 85, 100, 105, 125, 150, 155 |
| Damp heat, steady state days | 21, 42, 56 |

The detail specification shall prescribe the appropriate category.

3 Quality assessment procedures

3.1 Primary stage of manufacture

The primary stage of manufacture is defined as the initial mixing process of ingredients.

3.2 Structurally similar components

Surface mount thermistors may be grouped as structurally similar for the purpose of forming inspection lots provided that the requirements of 3.1 of IEC 60539-1 are met, with the following addition.

For the shear test and the substrate bending test, devices may be grouped if they have been made on the same production line, have the same dimensions, internal structure and external finish.

3.3 Qualification approval procedures

3.3.1 The manufacturer shall comply with 3.4 of IEC 60539-1.

3.4 Quality conformance inspection

Blank detail specifications associated with this specification shall prescribe the test schedule for quality conformance inspection.

This schedule shall also specify the grouping, sampling and periodicity for the lot-by-lot and periodic inspection.

Inspection levels and sampling plans shall be selected from those given in IEC 60410.

If required, more than one test schedule may be specified.

3.4.1 Qualification approval on the basis of the fixed sample size procedure

a) Sampling

The sample shall be representative of the range of thermistors for which approval is sought. This may or may not be the complete range covered by the detail specification.

The sample shall consist of specimens having the lowest, highest and middle-rated zero-power resistance of each case size.

Per value, three spare specimens are permitted and may be used as replacements for specimens which are defective because of incidents not attributable to the manufacturer.

b) Tests

The complete series of tests specified in Table 2 are required for the approval of thermistors covered by one detail specification. The tests of each group shall be carried out in the order given.

The whole sample shall be subjected to the tests of Group "0" and then divided for the other groups.

Specimens found defective during the tests of Group "0" shall not be used for the other groups.

"One defective" is counted when a thermistor has not satisfied the whole or a part of the tests of a group.

Approval is granted when the number of non-conformances does not exceed the specified number of permissible defects for each group or subgroup.

The conditions of test and performance requirements for the fixed sample size schedule shall be identical to those described in the detail specification for quality conformance inspection.

**Table 2 – Fixed sample size test schedule for qualification approval of surface mount negative temperature coefficient thermistors
Assessment level EZ**

| Group No. | Test | Subclause of this publication | Conditions of test and requirements | n ^{a)} | c ^{b)} | | |
|-----------|-------------------------------------------------------------|------------------------------------------------------------------|------------------------------------------------------------------|-----------------|-----------------|----|---|
| 0 | Visual examination | 4.3.1 | See 4.3.1 to 4.3.2 | 90 | 0 | | |
| | Marking | 4.3.3 | | | | | |
| | Dimensions (gauging) | 4.3.4 | For requirements, see Table A.1 | | | | |
| | Zero-power resistance | 4.4.1 | | | | | |
| 1 | Dimensions (detail) | 4.3.4 | For requirements, see Table A.1 | 10 | 0 | | |
| | B-value or resistance ratio | 4.4.2 | Choice to be made in the detail specification | | | | |
| | Resistance/temperature characteristic | 4.4.3 | Measuring temperatures to be defined in the detail specification | | | | |
| | Resistance to soldering heat – dissolution of metallization | 4.6 | See 4.6 | | | | |
| 2 | Solderability | 4.7 | See 4.7.1 to 4.7.3 | 10 | 0 | | |
| | Solvent resistance of marking | 4.16 | | | | | |
| 3 | Resistance to soldering heat – dewetting | 4.6 | See 4.6.1 to 4.6.4 | 10 | 0 | | |
| 4 | Mounting | 4.1 | | 60 | 0 | | |
| | Visual examination | 4.3.1 | | | | | |
| | Zero-power resistance | 4.4.1 | | | | | |
| | 4.1 | Dissipation factor | | 4.5.1 | 10 | 0 | |
| | | Thermal time constant by cooling after self-heating (τ_c) | | 4.5.2 | | | |
| | 4.2 | Shear test | | 4.13 | 10 | 0 | |
| | | Rapid change of temperature | | 4.8 | | | |
| | | Climatic sequence | | 4.10 | | | |
| | 4.3 | Damp heat, steady state | | 4.11 | 10 | 0 | |
| | 4.4 | Endurance at θ_3 and P_{max} | | 4.12.1 | 10 | 0 | |
| | 4.5 | Endurance at upper category temperature | | 4.12.2 | 10 | 0 | |
| | 5 | Substrate bending test | | 4.14 | | 10 | 0 |
| | ^{a)} Number of specimens to be tested. | | | | | | |
| | ^{b)} Permissible numbers of non-conforming items. | | | | | | |

3.5 Quality conformance inspection

3.5.1 Formation of inspection lots

a) Groups A and B inspection

These tests shall be carried out on a lot-by-lot basis.

A manufacturer may aggregate the current production into inspection lots subject to the following safeguards: